

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-ambient thermal resistance	$R_{\theta JA}$	50	°C/W
Junction-to-case thermal resistance	$R_{\theta JC}$	1.5	°C/W

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode ⁽¹⁾	$I_F = 12.5\text{A}, T_J = 25^\circ\text{C}$	V_F	-	0.70	V
	$I_F = 25.0\text{A}, T_J = 25^\circ\text{C}$		-	0.90	V
	$I_F = 12.5\text{A}, T_J = 125^\circ\text{C}$		-	0.60	V
	$I_F = 25.0\text{A}, T_J = 125^\circ\text{C}$		-	0.75	V
Reverse current @ rated V_R per diode ⁽²⁾	$T_J = 25^\circ\text{C}$	I_R	-	200	μA
	$T_J = 125^\circ\text{C}$		-	15	mA

Notes:

1. Pulse test with PW = 0.3ms
2. Pulse test with PW = 30ms

ORDERING INFORMATION		
ORDERING CODE	PACKAGE	PACKING
MBRS25H45CT	TO-263AB (D ² PAK)	800 / Tape & Reel

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

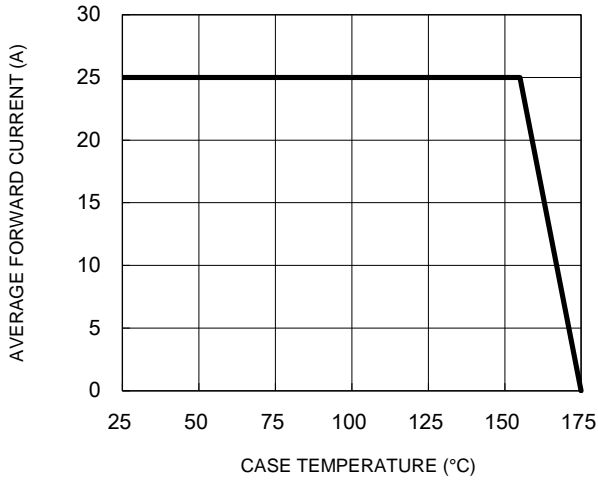


Fig.2 Typical Transient Thermal Impedance

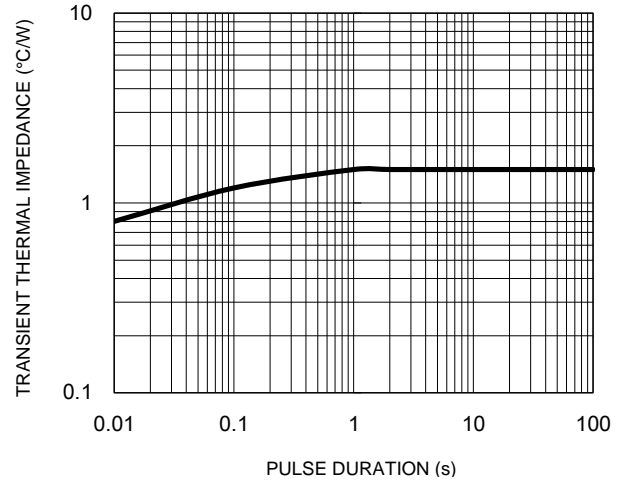


Fig.3 Typical Reverse Characteristics

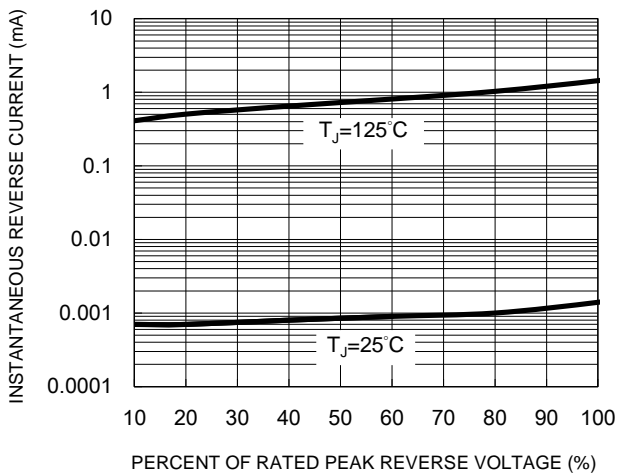


Fig.4 Typical Forward Characteristics

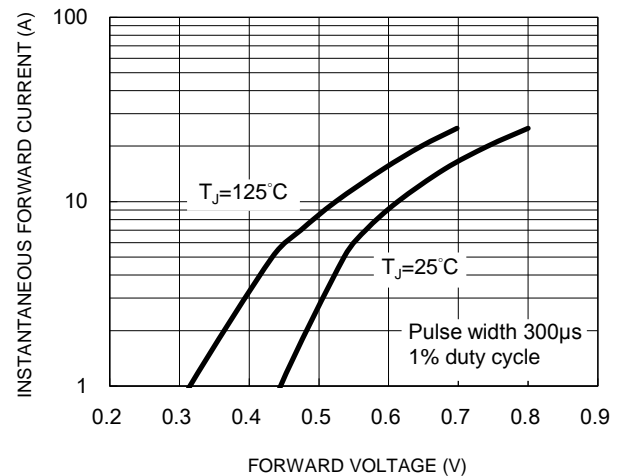
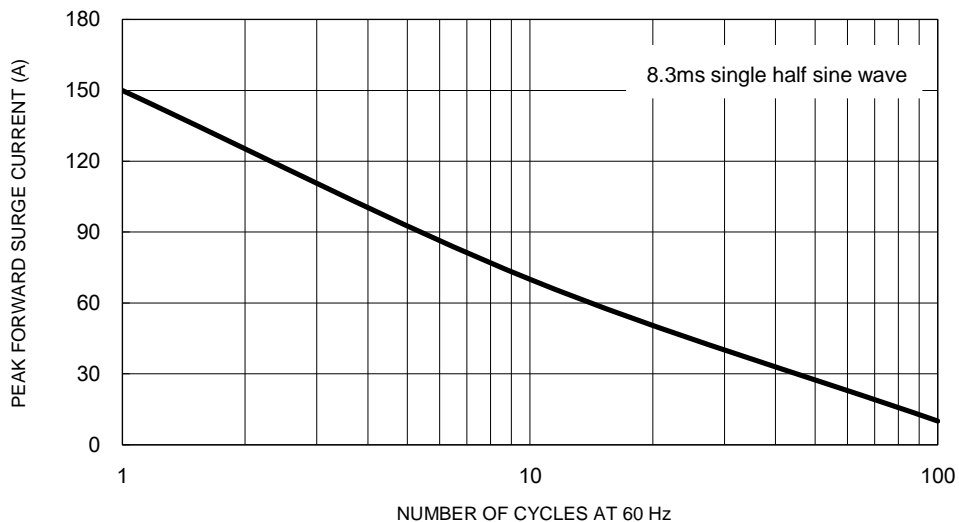
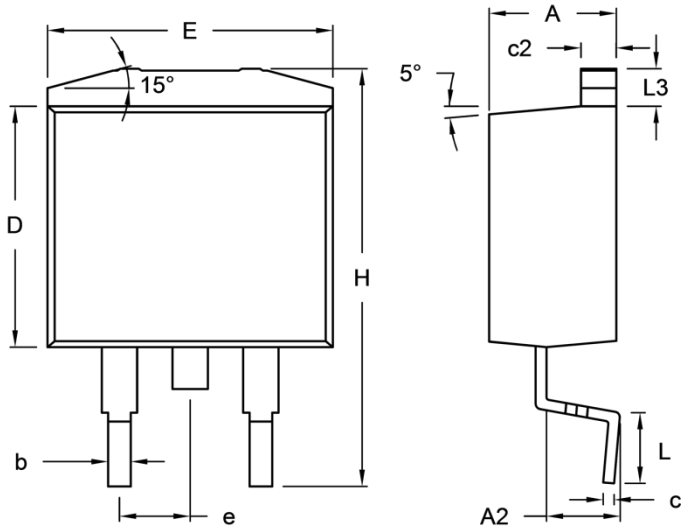


Fig.5 Maximum Non-Repetitive Forward Surge Current



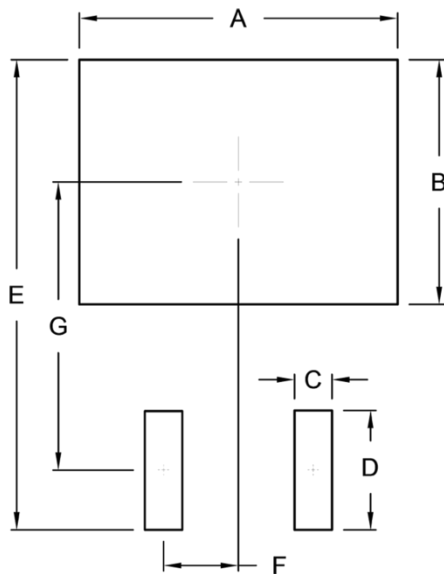
PACKAGE OUTLINE DIMENSIONS

TO-263AB (D²PAK)



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	4.44	4.70	0.175	0.185
A2	2.03	2.79	0.080	0.110
b	0.68	0.94	0.027	0.037
c	0.36	0.53	0.014	0.021
c2	1.14	1.40	0.045	0.055
D	8.25	9.25	0.325	0.364
E	-	10.50	-	0.413
e	2.41	2.67	0.095	0.105
H	14.60	15.88	0.575	0.625
L	2.29	2.79	0.090	0.110
L3	1.14	1.40	0.045	0.055

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	10.80	0.425
B	8.30	0.327
C	1.27	0.050
D	4.05	0.159
E	15.95	0.628
F	2.54	0.100
G	9.775	0.385

MARKING DIAGRAM



- P/N = Marking Code
- G = Green Compound
- YWW = Date Code
- F = Factory Code

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